

1A, 200V - 600V Surface Mount Super Fast Rectifier

FEATURES

- · Glass passivated junction chip
- Ideal for automated placement
- Low profile package
- Low power loss, high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

Λ	D	DI	14	$\sim \Lambda$	TI	1	M	c

- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in computer, automotive and telecommunication.

MECHANICAL DATA

- Case: SOD-123FL
- Molding compound meets UL 94 V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 16 mg (approximately)

KEY PARAMETERS						
PARAMETER VALUE UNIT						
I _{F(AV)}	1	Α				
V_{RRM}	200 - 600	V				
I _{FSM}	30	Α				
T _{J MAX}	150	°C				
Package	SOD-123FL					
Configuration	Single dice					









SOD-123FL

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)							
PARAMETER	SYMBOL	ES1DFL	ES1GFL	ES1JFL	UNIT		
Marking code on the device		EDF	EGF	EJF			
Repetitive peak reverse voltage	V_{RRM}	200	400	600	٧		
Reverse voltage, total rms value	V _{RMS}	140	280	420	V		
Maximum DC blocking voltage	V _{DC}	200	400	600			
Forward current	I _{F(AV)}		1		Α		
Surge peak forward current, 8.3 ms single half sinewave superimposed on rated load per diode	I _{FSM}		30		А		
Junction temperature	T _J		- 55 to +150		°C		
Storage temperature	T _{STG}		- 55 to +150		°C		

Taiwan Semiconductor

THERMAL PERFORMANCE							
PARAMETER	SYMBOL	TYP	UNIT				
Junction to Lead Thermal Resistance	$R_{\Theta JL}$	35	°C/W				
Junction to Ambient Thermal Resistance	$R_{\Theta JA}$	85	°C/W				

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
	ES1DFL		V _F	-	1.0	V
Forward voltage (1)	ES1GFL	I _F = 1A, T _J = 25°C		-	1.3	V
	ES1JFL			-	1.7	V
Reverse current @ rated V _R per diode ⁽²⁾		T _J = 25°C	I _R	-	5	μA
		T _J = 125°C		-	100	μA
Junction capacitance		1 MHz, V _R =4V	CJ	8	-	pF
Reverse recovery time		I _F =0.5A , I _R =1.0A I _{RR} =0.25A	t _{rr}	-	35	nS

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION								
PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING				
ES1xFL	-L RV	0	SOD-123FL	3,000 / 7" Plastic reel				
(Note1)	RQ	G	SOD-123FL	10,000 / 13" Paper reel				

Notes:

- 1. "x" defines voltage from 200V (ES1DFL) to 600V (ES1JFL)
- 2. Whole series with green compound

EXAMPLE						
EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION		
ES1JFL RVG	ES1JFL	RV	G	Green compound		



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig1. Forward Current Derating Curve

1.2 AVERAGE FORWARD CURRENT (A) 1 CAPACITANCE (pF) 8.0 0.6 0.4 Resistive or 0.2 inductive load 0 0 25 50 75 100 125 150 LEAD TEMPERATURE (°C)

Fig2. Typical Junction Capacitance

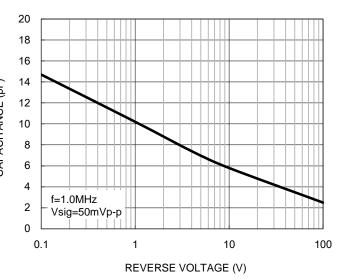


Fig3. Typical Reverse Characteristics

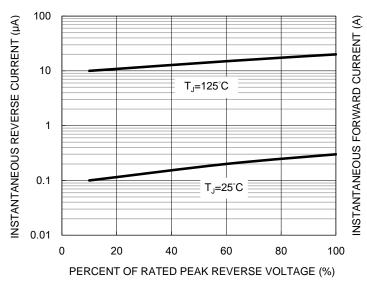
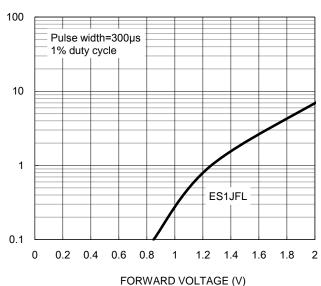


Fig4. Typical Forward Characteristics





CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig5. Maximum Non-repetitive Forward Surge Current

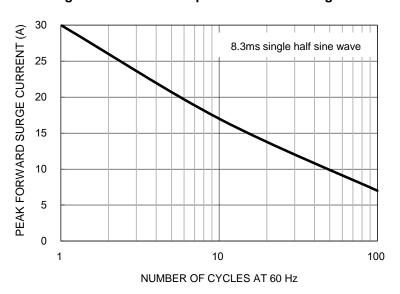
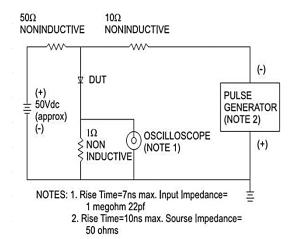
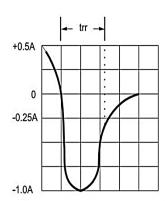


Fig6. Reverse Recovery Time Characteristic And Test Circuit Diagram

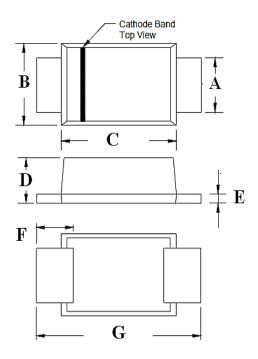






PACKAGE OUTLINE DIMENSIONS

SOD-123FL



DIM	Unit	(mm)	Unit (inch)		
DIM.	Min	Min Max		Max	
Α	0.80	1.15	0.031	0.045	
В	1.70	2.10	0.067	0.083	
С	2.60	3.10	0.102	0.122	
D	0.88	1.35	0.035	0.053	
E	0.10	0.30	0.004	0.012	
F	0.30	0.90	0.012	0.035	
G	3.45	3.95	0.136	0.156	

MARKING DIAGRAM



P/N = Marking Code ΥW = Date Code = Factory Code



Taiwan Semiconductor

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.